

www.vishay.com

Vishay Siliconix

Automotive P-Channel 60 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY						
V _{DS} (V)	-60					
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.095					
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.135					
I _D (A)	-5.3					
Configuration	Single					

Marking Code: 8R

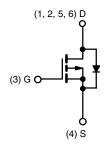
FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified c
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





ROHS COMPLIANT HALOGEN FREE



MOSFET

ORDERING INFORMATION	
Package	TSOP-6
Lead (Pb)-free and halogen-free	SQ3427EV (for detailed order number please see www.vishay.com/doc?79771)

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage	V _{DS}	-60	V			
Gate-Source Voltage	V_{GS}	± 20	V			
Continuous Drain Current	T _C = 25 °C	- I _D	-5.3			
Continuous Drain Current	T _C = 125 °C		-3			
Continuous Source Current (Diode Conduction	Continuous Source Current (Diode Conduction)			Α		
Pulsed Drain Current ^a	I _{DM}	-21				
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	-21			
Single Pulse Avalanche Energy	L = 0.1 mn	E _{AS}	22	mJ		
Maximum Power Dissipation ^a	T _C = 25 °C	P _D	5	W		
Maximum Fower Dissipation "	T _C = 125 °C		1.6	VV		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C		

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	LIMIT	UNIT			
Junction-to-Ambient	PCB Mount b	R_{thJA}	110	°C/W		
Junction-to-Foot (Drain)		R_{thJF}	30	G/VV		

Notes

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. When mounted on 1" square PCB (FR4 material).
- c. Parametric verification ongoing.



www.vishay.com

Vishay Siliconix

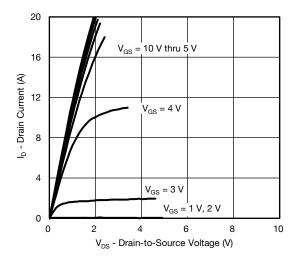
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$, $I_D = -250 \mu A$		-60	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = -250 μA	-1.5	-2	-2.5	V
Gate-Source Leakage	I _{GSS}	V _{DS} =	0 V, V _{GS} = ± 20 V	-		± 100	nA
		$V_{GS} = 0 V$	V _{DS} = -60 V	-	-	-1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V	V _{DS} = -60 V, T _J = 125 °C	-	-	-50	μΑ
		V _{GS} = 0 V	V _{DS} = -60 V, T _J = 175 °C	-	-	-150	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = -10 V	$V_{DS} \le -5 \text{ V}$	-10	-	-	Α
		V _{GS} = -10 V	I _D = -4.5 A	-	0.079	0.095	
Drain-Source On-State Resistance a		V _{GS} = -10 V	I _D = -4.5 A, T _J = 125 °C	-	-	0.148	Ω
Drain-Source On-State Resistance 4	R _{DS(on)}	V _{GS} = -10 V	I _D = -4.5 A, T _J = 175 °C	-	-	0.178	
		V _{GS} = -4.5 V	I _D = -3.5 A	-	0.112	0.135	
Forward Transconductance ^a	g _{fs}	V _{DS} = -15 V, I _D = -4 A		-	9	-	S
Dynamic ^b							
Input Capacitance	C _{iss}			-	700	1000	
Output Capacitance	Coss	$V_{GS} = 0 V$	$V_{DS} = -30 \text{ V, f} = 1 \text{ MHz}$	-	90	120	pF
Reverse Transfer Capacitance	C _{rss}			-	50	80	
Total Gate Charge ^c	Qg			-	15.3	22	
Gate-Source Charge ^c	Q _{gs}	$V_{GS} = -10 \text{ V}$	$V_{DS} = -30 \text{ V}, I_D = -5 \text{ A}$	-	2.5	-	nC
Gate-Drain Charge ^c	Q_{gd}			-	5.4	-	
Gate Resistance	R _g	f = 1 MHz		2.5	5	7.5	Ω
Turn-On Delay Time ^c	t _{d(on)}			-	8	12	
Rise Time ^c	t _r	V_{DD} = -30 V, R_L = 6 Ω I_D \cong -5 A, V_{GEN} = -10 V, R_g = 1 Ω		-	24	35	- ns
Turn-Off Delay Time ^c	t _{d(off)}			-	25	38	
Fall Time ^c	t _f				33	50	
Source-Drain Diode Ratings and Chara	icteristics ^b						
Pulsed Current a	I _{SM}			-	-	-21	Α
		$I_F = -1.6 \text{ A}, V_{GS} = 0 \text{ V}$					

Notes

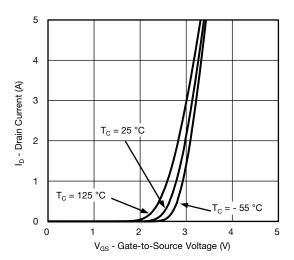
- d. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- e. Guaranteed by design, not subject to production testing.
- f. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

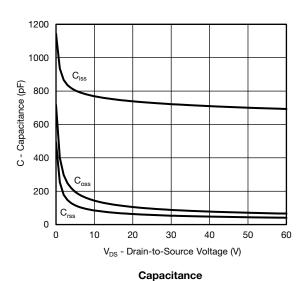


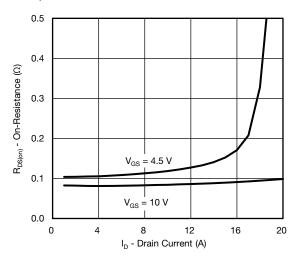


Output Characteristics

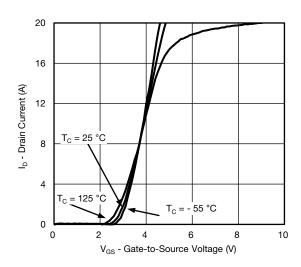


Transfer Characteristics

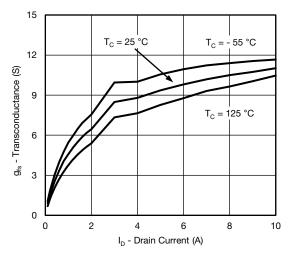




On-Resistance vs. Drain Current and Gate Voltage

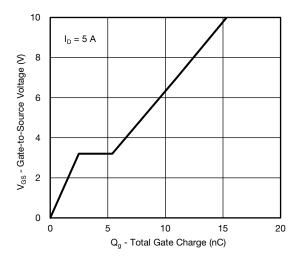


Transfer Characteristics

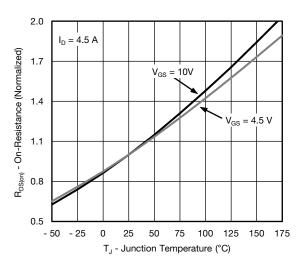


Transconductance

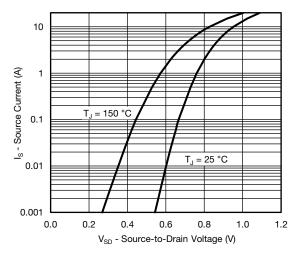




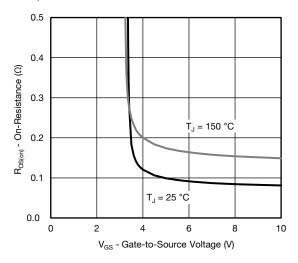
Gate Charge



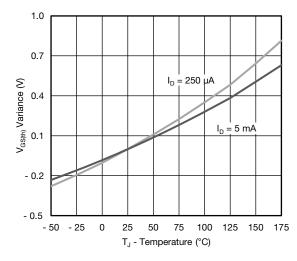
On-Resistance vs. Junction Temperature



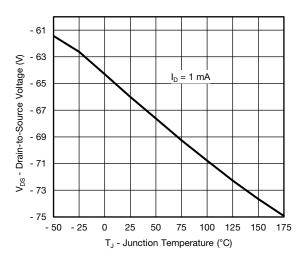
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage

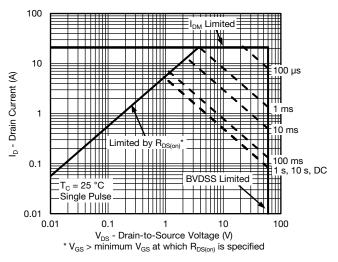


Threshold Voltage

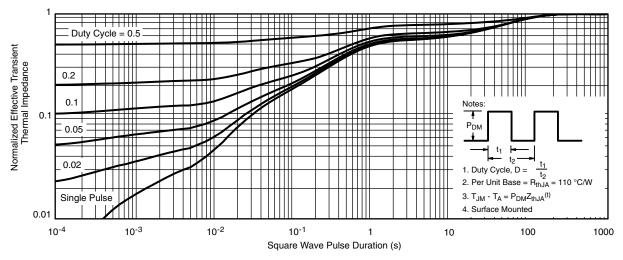


Drain-to-Source Voltage vs. Junction Temperature



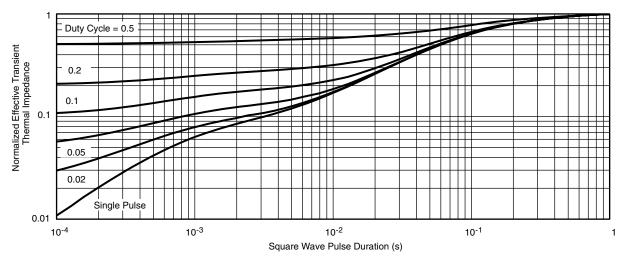


Safe Operating Area, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient





Normalized Thermal Transient Impedance, Junction-to-Foot

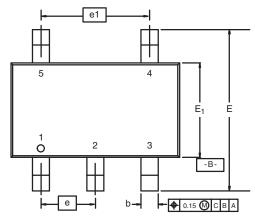
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?67987.

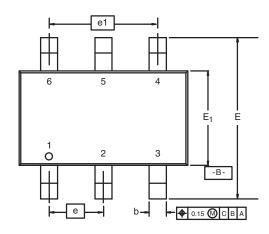




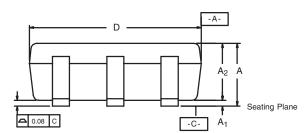
TSOP: 5/6-LEAD

JEDEC Part Number: MO-193C

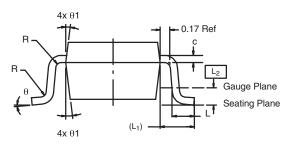




5-LEAD TSOP





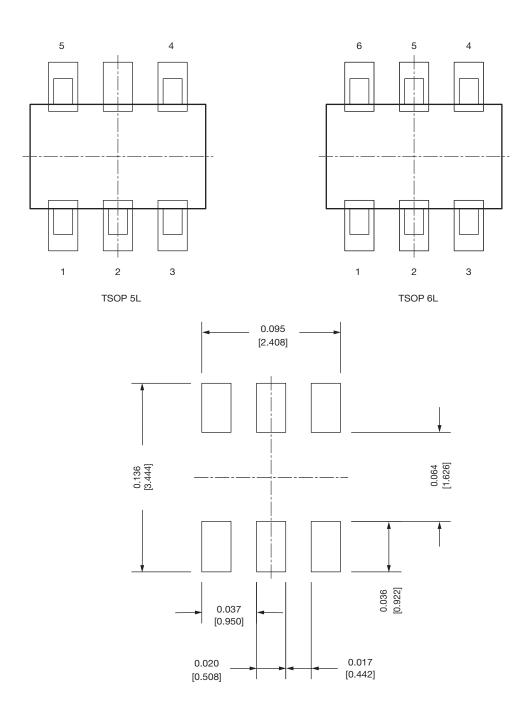


	MIL	LIMETER	RS	INCHES			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.91	-	1.10	0.036	-	0.043	
A ₁	0.01	-	0.10	0.0004	-	0.004	
A ₂	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
E	2.70	2.85	2.98	0.106	0.112	0.117	
E ₁	1.55	1.65	1.70	0.061	0.065	0.067	
е		0.95 BSC		(0.0374 BSC		
e ₁	1.80	1.90	2.00	0.071	0.075	0.079	
L	0.32	-	0.50	0.012	-	0.020	
L ₁	0.60 Ref			0.024 Ref			
L ₂		0.25 BSC			0.010 BSC		
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
θ1		7° Nom			7° Nom		
	ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540						

Document Number: 71200 18-Dec-06



Recommended Land Pattern For TSOP-5L / TSOP-6L



Note

• All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022 DWG: 3010



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.